

Crystal oscillator

CRYSTAL OSCILLATOR (Programmable) OUTPUT: CMOS

SG-8018 series

- Frequency range: 0.67 MHz to 170 MHz (1 ppm Step)
- Supply voltage : 1.62 V to 3.63 V
- Function : Output enable (OE) or Standby (ST)
- Frequency tolerance : ± 50 ppm (-40 °C to +105 °C)
 - Include frequency aging(+25 °C, 10 years)
- Package : 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 (mm)
- PLL technology to enable short lead time
- Available field oscillator programmer "SG-Writer II"



Product Number SG-8018CA: X1G005571xxxx00 SG-8018CB: X1G005581xxxx00 SG-8018CE: X1G005591xxxx00 SG-8018CG: X1G005601xxxx00



CG CE CB CA 2.5 x 2.0mm 3.2 x 2.5mm 5.0 x 3.2mm 7.0 x 5.0mm

Specifications (characteristics)

Item		Symbol		Specifi	cations	Conditions/Remarks				
Supply voltage		Vee	1.80 \	/ Тур.	2.50 V Typ.	3.30 V Typ.			_	
		VCC	1.62 V to 1.98 V	1.98 V to 2.20 V	2.20 V to 2.80 V	2.70 V to 3.63 V	-			
Output frequency range fo				0.67 MHz	to 170 MHz					
Storage tempe	rature	T_stg		-40 °C to	o +125 ℃	Storage as single product.				
Operating temp	perature	T_use		-40 °C to	o +105 ℃			-		
Frequency tole	rance ^{*1}	f_tol		J: ±50) × 10 ⁻⁶		T_use = -40 °C to +	105 °C		
			3.2 mA Max.	3.3 mA Max.	3.4 mA Max.	3.5 mA Max.	T_use = +105 °C	d f 20 MHz		
Current consur	notion	laa	2.7 r	2.7 mA Typ. 2.9 mA Typ. 3.0 mA Typ.				100000, 10 = 20 MHZ		
Current consul	прион	ICC	5.5 mA Max.	5.8 mA Max.	6.7 mA Max.	8.1 mA Max.	T_use = +105 ℃	Noloo	d f = 170 MUz	
			4.7 r	nA Typ.	5.7 mA Typ.	6.8 mA Typ.	T_use = +25 °C	u, 10 - 170 MITZ		
Output disable	current	I_dis	3.2 mA Max.	3.2 mA Max.	3.3 mA Max.	3.5 mA Max.	OE = GND, f ₀ = 170) MHz		
Standby ourror	*	Late	0.9 µA Max.	1.0 µA Max.	1.5 µA Max.	2.5 µA Max.	T_use = +105 ℃	<u>ет</u> – (סואכ	
Stanuby curren	it.	I_SIU	0.3 µA Typ.	0.4 µA Typ.	0.5 µA Typ.	1.1 µA Typ.	T_use = +25 °C	51-0		
Symmetry		SYM		45 % t	o 55 %		50 % V _{cc} Level			
							IOH/IOL Conditions		[mA]	
							Rise/Fall time	Vcc	*A *B *C *D	
		Vон		/cc Min.	Default (f _O > 40 MHz), I _{OH}	I _{OH}	-2.5 -3.5 -4.0 -5.0			
Output voltage						1 431	IOL	2.5 3.5 4.0 5.0		
(DC characteris	stics)				Default (f _O ≤ 40 MHz)	Юн	15 20 25 30			
· -	,	Vol			Slow lot	Іон	-1.0 -1.5 -2.0 -2.5			
			10 % V _{CC} Max.				Slow	IOL	1.0 1.5 2.0 2.5	
					*A: 1.62 V to 1.98 V, *B: 1.98 V to 2.20 V, *C: 2.20 V to 2.80 V, *D: 2.70 V to 3.63 V					
Output load co	ndition	L_CMOS		15 p	oF Max.			-		
		VIH		70 % \	/cc Min.	OE or ST				
input voltage		VIL		30 % V	cc Max.					
	Dofault			3.0	ns Max.		f ₀ > 40 MHz			
Rise and Fall	Delault	tr/tf		6.0 ns Max.					20 % - 80 % Vcc,	
time	Fast	u/u		3.0 ns Max.				0 MHz	L_CMOS = 15 pF	
1	Slow			ns Max.	f _O = 0.67 MHz to 20 MHz					
Disable Time		t_stp		µs Max.	Measured from the time OE or \overline{ST} pin crosses 30 % V _{CC}					
Enable Time		t_sta		us Max.	Measured from the time OE pin crosses 70 % V_{CC}					
Resume Time		t_res		3 n	ns Max.		Measured from the time \overline{ST} pin crosses 70 % V _{CC}			
Start-up time		t_str		ns Max.	Measured from the time V_{CC} reaches its rated minimum value, 1.62 V					
Frequency agir	ng	f_aging	This is ir	ncluded in frequer	ncy tolerance spe	cification.	+25 °C, 10 years			
							1.10 1 1 1.10 1			

*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage variation, reflow drift, load drift and aging (+25 °C, 10 years).

P	in description			
Pin	Name	I/O type		Function
	0	Input	Output enable	High: Specified frequency output from OUT pin
	UE			Low: Out pin is low (weak pull down), only output driver is disabled.
1	1 <u>ST</u>	Input	Standby	High: Specified frequency output from OUT pin
				Low: Out pin is low (weak pull down),
				Device goes to standby mode. Supply current reduces to the least as I_std.
2	GND	Power	Ground	
3	OUT	Output	Clock output	
4	V _{CC}	Power	Power supply	

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together with short wiring pattern.







Output disable current



Notes:











(Integration bandwidth 12 k-20 MHz)





Period Jitter RMS



Period Jitter Peak-Peak





Cycle-to-Cycle Jitter Peak-Peak

Notes:



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Specification Graph

(Typical supplemental specification. Unless otherwise specified T_use = 25 °C, L_CMOS = 15 pF, VCC = 3.3 V) Rise/Fall Time (fo = 20 MHz)









Harmonics spectrum (fo = 20 MHz)



Harmonics comparison







■Notes:

frequency	slow	default	fast
0.67 M – 20 MHz	See Slow	See Default	See Fast
20 M – 40 MHz	-	See Default	See Fast
40 M – 170 MHz	-	See Fast	See Fast



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ESD Rading	
Test items	Breakdown voltage
Human Body Model (HBM)	2000 V
Machine Model (MM)	250 V
Charged Device Model (CDM)	750 V



Simulation Model

IBIS Model is available upon request. Please contact us. Information Required: Oscillator operating condition (i.e. Power Supply, Rise/Fall Time, Temperature) Crystal oscillator

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Device Material & Environmental Information

Model	Package	# of	Reference	Terminal	Terminal	Complies	Pb	MSL	Peak
	Dimensions	Pins	Weight	Material	Plating	With EU	Free	Rating	Temp.
			(Typ.)		-	RoHS			(Max)
SG-8018CG	2.5 x 2.0 x 0.7 mm	4	13 mg	W	Au	Yes	Yes	1	260 °C
SG-8018CE	3.2 x 2.5 x 1.0 mm	4	25 mg	W	Au	Yes	Yes	1	260 °C
SG-8018CB	5.0 x 3.2 x 1.1 mm	4	51 mg	W	Au	Yes	Yes	1	260 °C
SG-8018CA	7.0 x 5.0 x 1.3 mm	4	143 mg	W	Au	Yes	Yes	1	260 °C

SMD products Reflow profile(example)

The availability of the heat resistance for reflow conditions of JEDEC-STD-020D.01 is judged individually. Please inquire.



Pb Free	• Pb free.
RoHS Compliant	 Complies with EU RoHS directive. About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)

Standard Packing Specification

SMD products are packed in the shipping carton as below table in accordance with taping standards EIA-481 and IEC-60286







Standard Packing Quantity & Dimension(Unit mm)									
Model	Quantity (pcs/Reel)	Reel Dimension			Career Tape Dimension				Direction of
		а	b	W	А	В	С	D	Feed (L= Left Direction)
SG-8018CG	3000	Φ180	Ф60	9	4	5.25	8	1.15	L
SG-8018CE	2000	Φ180	Ф60	9	4	5.25	8	1.4	L
SG-8018CB	1000	Φ180	Ф60	13	8	7.25	12	1.4	L
SG-8018CA	1000	Φ254	Φ100	17.5	8	9.25	16	2.3	L

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